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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|--------------------------------|---|
| Product Status | Active |
| Number of LABs/CLBs | 217080 |
| Number of Logic Elements/Cells | 570000 |
| Total RAM Bits | 42082304 |
| Number of I/O | 396 |
| Number of Gates | - |
| Voltage - Supply | 0.87V ~ 0.93V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 100°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FCBGA (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/10ax057k3f35e2lg |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

A10-OVERVIEW | 2018.04.09



| Feature | | Description | | | | |
|--------------------------------------|--|--|--|--|--|--|
| Embedded Hard IP blocks | Variable-precision DSP | Native support for signal processing precision levels from 18 x 19 to 54 x 54 Native support for 27 x 27 multiplier mode 64-bit accumulator and cascade for systolic finite impulse responses (FIRs) Internal coefficient memory banks Preadder/subtractor for improved efficiency Additional pipeline register to increase performance and reduce power Supports floating point arithmetic: Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication. Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability. Dynamic accumulator reset control. Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks. | | | | |
| | Memory controller | DDR4, DDR3, and DDR3L | | | | |
| | PCI Express* | PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port | | | | |
| | Transceiver I/O | 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) PCS hard IPs that support: | | | | |
| Core clock networks | 667 MHz externa 800 MHz LVDS in Global, regional, and | c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power | | | | |
| Phase-locked loops (PLLs) | High-resolution fractional synthesis PLLs: — Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) — Support integer mode and fractional mode — Fractional mode support with third-order delta-sigma modulation Integer PLLs: — Adjacent to general purpose I/Os — Support external memory and LVDS interfaces | | | | | |
| FPGA General-purpose I/Os (GPIOs) | 1.6 Gbps LVDS—every pair can be configured as receiver or transmitter On-chip termination (OCT) 1.2 V to 3.0 V single-ended LVTTL/LVCMOS interfacing | | | | | |
| External Memory Interface | Hard memory controller— DDR4, DDR3, and DDR3L support DDR4—speeds up to 1,200 MHz/2,400 Mbps DDR3—speeds up to 1,067 MHz/2,133 Mbps Soft memory controller—provides support for RLDRAM 3 ⁽²⁾ , QDR IV ⁽²⁾ , and QDR II+ continued | | | | | |



| Feature | | Description | | | | | |
|--|--|--|--|--|--|--|--|
| Low-power serial transceivers | - Intel Arria 10 GT- Backplane support: - Intel Arria 10 GX- Intel Arria 10 GT- Extended range dow ATX transmit PLLs w Electronic Dispersion module Adaptive linear and of | X—1 Gbps to 17.4 Gbps T—1 Gbps to 25.8 Gbps x—up to 12.5 | | | | | |
| HPS (Intel Arria 10 SX devices only) | Processor and system | Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability 256 KB on-chip RAM and 64 KB on-chip ROM System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA) ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage | | | | | |
| | External interfaces | Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I²C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os) | | | | | |
| | Interconnects to core | High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller | | | | | |
| Configuration | Enhanced 256-bit ad | comprehensive design protection to protect your valuable IP investments dvanced encryption standard (AES) design security with authentication obtocol (CvP) using PCIe Gen1, Gen2, or Gen3 | | | | | |
| | | continued | | | | | |

 $^{^{(2)}}$ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



| Feature | Description |
|--------------------|--|
| | Dynamic reconfiguration of the transceivers and PLLs Fine-grained partial reconfiguration of the core fabric Active Serial x4 Interface |
| Power management | SmartVID Low static power device options Programmable Power Technology Intel Quartus Prime integrated power analysis |
| Software and tools | Intel Quartus Prime design suite Transceiver toolkit Platform Designer system integration tool DSP Builder for Intel FPGAs OpenCL™ support Intel SoC FPGA Embedded Design Suite (EDS) |

Related Information

Intel Arria 10 Transceiver PHY Overview

Provides details on Intel Arria 10 transceivers.

Intel Arria 10 Device Variants and Packages

Table 4. **Device Variants for the Intel Arria 10 Device Family**

| Variant | Description |
|-------------------|---|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |
| Intel Arria 10 GT | FPGA featuring: 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. 25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules. |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |

Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.



Available Options

Figure 1. Sample Ordering Code and Available Options for Intel Arria 10 GX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



Available Options

Figure 2. Sample Ordering Code and Available Options for Intel Arria 10 GT Devices





Maximum Resources

Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices

| Reso | ource | Produc | ct Line | |
|------------------------------|-----------------------------|-------------------|-------------------|--|
| | | GT 900 | GT 1150 | |
| Logic Elements (LE) (K) | | 900 | 1,150 | |
| ALM | | 339,620 | 427,200 | |
| Register | | 1,358,480 | 1,708,800 | |
| Memory (Kb) | M20K | 48,460 | 54,260 | |
| | MLAB | 9,386 | 12,984 | |
| Variable-precision DSP Block | rriable-precision DSP Block | | 1,518 | |
| 18 x 19 Multiplier | | 3,036 | 3,036 | |
| PLL | Fractional Synthesis | 32 | 32 | |
| | I/O | 16 | 16 | |
| Transceiver | 17.4 Gbps | 72 ⁽⁵⁾ | 72 ⁽⁵⁾ | |
| | 25.8 Gbps | 6 | 6 | |
| GPIO ⁽⁶⁾ | | 624 | 624 | |
| LVDS Pair ⁽⁷⁾ | | 312 | 312 | |
| PCIe Hard IP Block | | 4 | 4 | |
| Hard Memory Controller | | 16 | 16 | |

Related Information

Intel Arria 10 GT Channel Usage

Configuring GT/GX channels in Intel Arria 10 GT devices.

Package Plan

Table 11. Package Plan for Intel Arria 10 GT Devices

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | SF45 (45 mm × 45 mm, 1932-pin FBGA) | | | | |
|--------------|--|----------|------|--|--|
| | 3 V I/O | LVDS I/O | XCVR | | |
| GT 900 | _ | 624 | 72 | | |
| GT 1150 | _ | 624 | 72 | | |

⁽⁵⁾ If all 6 GT channels are in use, 12 of the GX channels are not usable.

⁽⁶⁾ The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

⁽⁷⁾ Each LVDS I/O pair can be used as differential input or output.



| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | | | F29 (29 mm × 29 mm, 780-pin FBGA) | | | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | | |
|--------------|---|-------------|------|------------|---|------|------------|--|------|------------|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 480 | _ | _ | _ | _ | _ | _ | 48 | 312 | 12 | 48 | 444 | 24 |
| SX 570 | _ | _ | _ | _ | _ | _ | _ | _ | _ | 48 | 444 | 24 |
| SX 660 | _ | _ | _ | _ | _ | _ | _ | _ | _ | 48 | 444 | 24 |

Table 14. Package Plan for Intel Arria 10 SX Devices (F35, KF40, and NF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F35 (35 mm × 35 mm, 1152-pin FBGA) | | | (35 mm × 35 mm, (40 mm × 40 mm, | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | |
|---------------------|--|----------|------|---------------------------------|-----|---------|---|------|----|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O LVDS I/O XCVR | | 3 V I/O | LVDS I/O | XCVR | |
| SX 270 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ |
| SX 320 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ |
| SX 480 | 48 | 348 | 36 | _ | _ | _ | _ | _ | _ |
| SX 570 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| SX 660 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |

Related Information

 ${\rm I/O}$ and High-Speed Differential ${\rm I/O}$ Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.



| Variant | Product Line | Variable- precision | Independent In Multiplication | | 18 x 19 Multiplier | 18 x 18 Multiplier Adder | |
|---------|--------------|------------------------|----------------------------------|-----------------------|-----------------------|--------------------------------|--|
| | | DSP Block | 18 x 19 Multiplier | 27 x 27 Multiplier | Adder Sum Mode | Summed with 36 bit Input | |
| | SX 320 | 984 | 1,968 | 984 | 984 | 984 | |
| | SX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 | |
| | SX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 | |
| | SX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 | |

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable- precision DSP Block | Single Precision Floating-Point Multiplication Mode | Single-Precision Floating-Point Adder Mode | Single- Precision Floating-Point Multiply Accumulate Mode | Peak Giga Floating- Point Operations per Second (GFLOPs) |
|----------------|--------------|-------------------------------------|---|--|--|--|
| Intel Arria 10 | GX 160 | 156 | 156 | 156 | 156 | 140 |
| GX | GX 220 | 192 | 192 | 192 | 192 | 173 |
| | GX 270 | 830 | 830 | 830 | 830 | 747 |
| | GX 320 | 984 | 984 | 984 | 984 | 886 |
| | GX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | GX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | GX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |
| | GX 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GX 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | GT 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| GT | GT 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | SX 160 | 156 | 156 | 156 | 156 | 140 |
| SX | SX 220 | 192 | 192 | 192 | 192 | 173 |
| | SX 270 | 830 | 830 | 830 | 830 | 747 |
| | SX 320 | 984 | 984 | 984 | 984 | 886 |
| | SX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | SX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | SX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Intel Arria 10 Devices

Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices

| | Product | M2 | 20K | ML | Total RAM Bit | |
|-------------------|---------|-------|--------------|--------|---------------|--------|
| Variant | Line | Block | RAM Bit (Kb) | Block | RAM Bit (Kb) | (Kb) |
| Intel Arria 10 GX | GX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | GX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | GX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | GX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | GX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | GX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | GX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |
| | GX 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GX 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 GT | GT 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GT 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 SX | SX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | SX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | SX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | SX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | SX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | SX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | SX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |



- Series (R_S) and parallel (R_T) on-chip termination (OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture

External Memory Interface

Intel Arria 10 devices offer massive external memory bandwidth, with up to seven 32-bit DDR4 memory interfaces running at up to 2,400 Mbps. This bandwidth provides additional ease of design, lower power, and resource efficiencies of hardened high-performance memory controllers.

The memory interface within Intel Arria 10 FPGAs and SoCs delivers the highest performance and ease of use. You can configure up to a maximum width of 144 bits when using the hard or soft memory controllers. If required, you can bypass the hard memory controller and use a soft controller implemented in the user logic.

Each I/O contains a hardened DDR read/write path (PHY) capable of performing key memory interface functionality such as read/write leveling, FIFO buffering to lower latency and improve margin, timing calibration, and on-chip termination.

The timing calibration is aided by the inclusion of hard microcontrollers based on Intel's Nios® II technology, specifically tailored to control the calibration of multiple memory interfaces. This calibration allows the Intel Arria 10 device to compensate for any changes in process, voltage, or temperature either within the Intel Arria 10 device itself, or within the external memory device. The advanced calibration algorithms ensure maximum bandwidth and robust timing margin across all operating conditions.

In addition to parallel memory interfaces, Intel Arria 10 devices support serial memory technologies such as the Hybrid Memory Cube (HMC). The HMC is supported by the Intel Arria 10 high-speed serial transceivers which connect up to four HMC links, with each link running at data rates up to 15 Gbps.

Related Information

External Memory Interface Spec Estimator

Provides a parametric tool that allows you to find and compare the performance of the supported external memory interfaces in IntelFPGAs.

Memory Standards Supported by Intel Arria 10 Devices

The I/Os are designed to provide high performance support for existing and emerging external memory standards.



Table 20. Memory Standards Supported by the Hard Memory Controller

This table lists the overall capability of the hard memory controller. For specific details, refer to the External Memory Interface Spec Estimator and Intel Arria 10 Device Datasheet.

| Memory Standard | Rate Support | Ping Pong PHY Support | Maximum Frequency (MHz) |
|-----------------|--------------|-----------------------|-------------------------|
| DDR4 SDRAM | Quarter rate | Yes | 1,067 |
| | | _ | 1,200 |
| DDR3 SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 1,067 |
| | | _ | 1,067 |
| DDR3L SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 933 |
| | | _ | 933 |
| LPDDR3 SDRAM | Half rate | _ | 533 |
| | Quarter rate | _ | 800 |

Table 21. Memory Standards Supported by the Soft Memory Controller

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------------------|--------------|----------------------------|
| RLDRAM 3 (11) | Quarter rate | 1,200 |
| QDR IV SRAM ⁽¹¹⁾ | Quarter rate | 1,067 |
| QDR II SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ Xtreme SRAM | Full rate | 333 |
| | Half rate | 633 |

Table 22. Memory Standards Supported by the HPS Hard Memory Controller

The hard processor system (HPS) is available in Intel Arria 10 SoC devices only.

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------|--------------|----------------------------|
| DDR4 SDRAM | Half rate | 1,200 |
| DDR3 SDRAM | Half rate | 1,067 |
| DDR3L SDRAM | Half rate | 933 |

⁽¹¹⁾ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices



Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



PMA Features

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices

| Feature | Capability | | | |
|--|--|--|--|--|
| Chip-to-Chip Data Rates | 1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices) 1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices) | | | |
| Backplane Support | Drive backplanes at data rates up to 12.5 Gbps | | | |
| Optical Module Support | SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4 | | | |
| Cable Driving Support | SFP+ Direct Attach, PCI Express over cable, eSATA | | | |
| Transmit Pre-Emphasis | 4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss | | | |
| Continuous Time Linear Equalizer (CTLE) | Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss | | | |
| Decision Feedback Equalizer (DFE) | 7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments | | | |
| Variable Gain Amplifier | Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes | | | |
| Altera Digital Adaptive Parametric Tuning (ADAPT) | Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic | | | |
| Precision Signal Integrity Calibration Engine (PreSICE) | Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance | | | |
| Advanced Transmit (ATX) PLL | Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols | | | |
| Fractional PLLs | On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost | | | |
| Digitally Assisted Analog CDR | Superior jitter tolerance with fast lock time | | | |
| Dynamic Partial Reconfiguration | Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility | | | |
| Multiple PCS-PMA and PCS- PLD interface widths | 8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency | | | |

PCS Features

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.





| PCS | Description |
|---------------|--|
| Standard PCS | Operates at a data rate up to 12 Gbps Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules. |
| Enhanced PCS | Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA Handles data transfer to and from the FPGA fabric Handles data transfer internally to and from the PMA Provides frequency compensation Performs channel bonding for multi-channel low skew applications |
| PCIe Gen3 PCS | Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates Provides support for PIPE 3.0 features Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed |

Related Information

- PCIe Gen1, Gen2, and Gen3 Hard IP on page 26
- Interlaken Support on page 26
- 10 Gbps Ethernet Support on page 26

PCS Protocol Support

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|--|---------------------|-----------------------------|-----------------------------------|
| PCIe Gen3 x1, x2, x4, x8 | 8.0 | Native PHY (PIPE) | Standard PCS and PCIe Gen3 PCS |
| PCIe Gen2 x1, x2, x4, x8 | 5.0 | Native PHY (PIPE) | Standard PCS |
| PCIe Gen1 x1, x2, x4, x8 | 2.5 | Native PHY (PIPE) | Standard PCS |
| 1000BASE-X Gigabit Ethernet | 1.25 | Native PHY | Standard PCS |
| 1000BASE-X Gigabit Ethernet with IEEE 1588v2 | 1.25 | Native PHY | Standard PCS |
| 10GBASE-R | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with IEEE 1588v2 | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with KR FEC | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-KR and 1000BASE-X | 10.3125 | 1G/10GbE and 10GBASE-KR PHY | Standard PCS and Enhanced PCS |
| Interlaken (CEI-6G/11G) | 3.125 to 17.4 | Native PHY | Enhanced PCS |
| SFI-S/SFI-5.2 | 11.2 | Native PHY | Enhanced PCS |
| 10G SDI | 10.692 | Native PHY | Enhanced PCS |
| | • | | continued |



Figure 9. HPS Block Diagram

This figure shows a block diagram of the HPS with the dual ARM Cortex-A9 MPCore processor.



Key Advantages of 20-nm HPS

The 20-nm HPS strikes a balance between enabling maximum software compatibility with 28-nm SoCs while still improving upon the 28-nm HPS architecture. These improvements address the requirements of the next generation target markets such as wireless and wireline communications, compute and storage equipment, broadcast and military in terms of performance, memory bandwidth, connectivity via backplane and security.



Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
 - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit
 Thumb instructions, and 8-bit Java byte codes in Jazelle style
 - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
 - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
 - 32 KB of L1 instruction cache, 32 KB of L1 data cache
 - Single- and double-precision floating-point unit and NEON media engine
 - CoreSight debug and trace technology
 - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I²C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
 - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
 - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

Enhanced Configuration and Configuration via Protocol

Table 25. Configuration Schemes and Features of Intel Arria 10 Devices

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) (13) | Decompression | Design Security ⁽¹ 4) | Partial Reconfiguration (15) | Remote System Update |
|--|------------------|----------------------------|------------------------------------|---------------|--|------------------------------------|---|
| JTAG | 1 bit | 33 | 33 | _ | _ | Yes ⁽¹⁶⁾ | _ |
| Active Serial (AS) through the EPCQ-L configuration device | 1 bit, 4 bits | 100 | 400 | Yes | Yes | Yes ⁽¹⁶⁾ | Yes |
| Passive serial (PS) through CPLD or external microcontroller | 1 bit | 100 | 100 | Yes | Yes | Yes ⁽¹⁶⁾ | Parallel Flash Loader (PFL) IP core |
| | continued | | | | | ntinued | |

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁶⁾ Partial configuration can be performed only when it is configured as internal host.



| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) | Decompression | Design Security ⁽¹ 4) | Partial Reconfiguration (15) | Remote System Update |
|--|----------------------------|----------------------------|----------------------------|---------------|--|------------------------------------|----------------------------|
| Fast passive | 8 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | PFL IP |
| parallel (FPP) through CPLD or | 16 bits | | | Yes | Yes | | core |
| external microcontroller | 32 bits | | | Yes | Yes | | |
| Configuration via | 16 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | _ |
| HPS | 32 bits | | | Yes | Yes | | |
| Configuration via Protocol [CvP (PCIe*)] | x1, x2, x4, x8 lanes | _ | 8000 | Yes | Yes | Yes ⁽¹⁶⁾ | _ |

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

SEU Error Detection and Correction

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

Power Management

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁷⁾ Supported at a maximum clock rate of 100 MHz.



| Date | Version | Changes |
|----------------|------------|---|
| December 2015 | 2015.12.14 | Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb. |
| | | Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources. |
| November 2015 | 2015.11.02 | • Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660. |
| | | Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in Number of Multipliers in Intel Arria 10 Devices table. |
| | | Updated the available options for Arria 10 GX, GT, and SX. Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>. |
| June 2015 | 2015.06.15 | Corrected label for Intel Arria 10 GT product lines in the vertical migration figure. |
| May 2015 | 2015.05.15 | Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller. |
| May 2015 | 2015.05.04 | Added support for 13.5G JESD204b in the Summary of Features table. Added support for 13.5G JESD204b in the Summary of Features table. |
| | | Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic. |
| | | Added a note to the table, Maximum Resource Counts for Arria 10 GT devices. |
| | | Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic. |
| January 2015 | 2015.01.23 | Added floating point arithmetic features in the Summary of Features table. |
| | | Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb. |
| | | Updated the table that lists the memory standards supported by Intel Arria 10 devices. |
| | | Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2. Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller. |
| | | Added soft memory controller support for QDR IV. |
| | | Updated the maximum resource count table to include the number of hard memory controllers available in each device variant. |
| | | Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps. |
| | | Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz. |
| | | Added a feature for fractional synthesis PLLs: PLL cascading. |
| | | Updated the HPS programmable general-purpose I/Os from 54 to 62. |
| September 2014 | 2014.09.30 | Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX. |
| | | Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660. |
| | | Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150. |
| | | continued |

Intel® Arria® 10 Device Overview

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| Date | Version | Changes |
|---------------|------------|---|
| August 2014 | 2014.08.18 | Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620. |
| | | Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table. |
| | | Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration. |
| | | Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller. |
| | | Added variable precision DSP blocks support for floating-point arithmetic. |
| June 2014 | 2014.06.19 | Updated number of dedicated I/Os in the HPS block to 17. |
| February 2014 | 2014.02.21 | Updated transceiver speed grade options for GT devices in Figure 2. |
| February 2014 | 2014.02.06 | Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps. |
| December 2013 | 2013.12.10 | Updated the HPS memory standards support from LPDDR2 to LPDDR3. Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks . |
| December 2013 | 2013.12.02 | Initial release. |